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# AOZ8175

### 6-Line EMI Filter with Integrated ESD Protection

### **General Description**

The AOZ8175 is a 6-line device integrating EMI filtering with ESD protection for each line. It is designed to suppress unwanted EMI/RFI signals and provide electrostatic discharge (ESD) protection in portable electronic equipment. This state-of-the-art device utilizes AOS leading edge Trench Vertical Structure [TVS]<sup>2</sup> TM technology for superior clamping performance and filter attenuation over the full operating display range. The AOZ8175 has been optimized for protection of color LCD displays and CCD camera lines in cellular phones and other portable consumer electronic devices.

The AOZ8175 consists of six identical circuits comprised of TVS diodes for ESD protection, and a resistor–capacitor network for EMI/RFI filtering. A series resistor value of  $100\Omega$  and a capacitance value of 8pF are used to achieve -20dB minimum attenuation from 700MHz to 3.0GHz. The TVS diodes provide effective suppression of ESD voltages in excess of  $\pm 15$ kV (contact discharge) and  $\pm 15$ kV (air discharge). This exceeds IEC 61000-4-2, level 4 ESD immunity test.

The AOZ8175 comes in an RoHS compliant, 3.0mm x 1.35mm DFN package and is rated over a -40°C to +85°C ambient temperature range.

#### **Features**

- 6 lines for EMI filtering and ESD protection:
  - Exceeds IEC 61000-4-2, level 4 (ESD) immunity test
  - ±15kV (contact discharge) and ±15kV (air discharge)
- Trench Vertical Structure [TVS]<sup>2</sup> ™ based technology used to achieve excellent ESD clamping and filter performance over the full operating display range
- Filter performance: -20db attenuation from 700MHz to 3.0GHz
- Low operating voltage: 5.0V
- Capacitance stability over wide range of voltages and temperatures
- DFN package 3.0mm x 1.35mm
- Pb-Free device

### **Applications**

- EMI filtering and ESD protection for data lines
- LCD displays, camera interface, I/O interface
- Portable handheld devices, cell phones, PDA phones



### **Electrical Schematic**

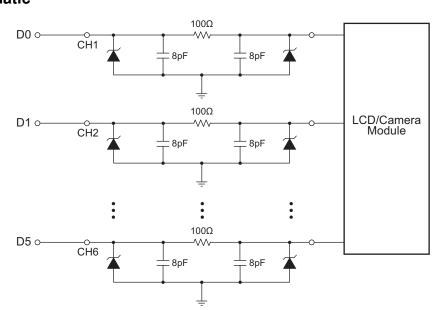


Figure 1.



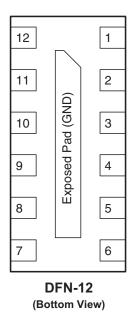
### **Ordering Information**

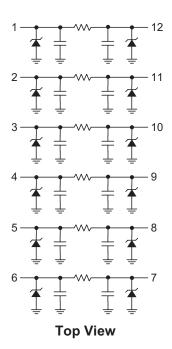
	Part Number	Ambient Temperature Range	Package	Environmental		
Ī	AOZ8175DI	-40°C to +85°C	DFN-12	Green Product		



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant. Please visit www.aosmd.com/web/quality/rohs\_compliant.jsp for additional information.

### **Pin Configuration**





### **Pin Description**

Pin Number	Pin Name	Pin Function
1,12	CH 1	Channel 1 Connections
2, 11	CH 2	Channel 2 Connections
3, 10	CH 3	Channel 3 Connections
4, 9	CH 4	Channel 4 Connections
5, 8	CH 5	Channel 5 Connections
6, 7	CH 6	Channel 6 Connections
Exposed Pad	GND	Common Ground Connection

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### **Absolute Maximum Ratings**

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating
Storage Temperature (T <sub>S</sub> )	-65°C to +150°C
ESD Rating per IEC61000-4-2, contact <sup>(1)</sup>	±15kV
ESD Rating per IEC61000-4-2, air <sup>(1)</sup>	±15kV
ESD Rating per Human Body Model <sup>(2)</sup>	±30kV

#### Notes:

- 1. IEC 61000-4-2 discharge with  $C_{Discharge}$  = 150pF,  $R_{Discharge}$  = 330 $\Omega$ .
- 2. Human Body Discharge per MIL-STD-883, Method 3015  $C_{Discharge}$  = 100pF,  $R_{Discharge}$  = 1.5k $\Omega$ .

#### **Electrical Characteristics**

 $T_A = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V <sub>RWM</sub>	Reverse Working Voltage	(3)			5.0	V
V <sub>BR</sub>	Reverse Breakdown Voltage	$I_{T} = 1 \text{mA}^{(4)}$	6	7	8	V
I <sub>R</sub>	Reverse Leakage Current	V <sub>RWM</sub> = 3.3V			0.1	μΑ
V <sub>CL</sub>	Signal Clamp Voltage	I <sub>LOAD</sub> = 1A, positive clamp <sup>(5)(8)</sup>			9.0	V
		$I_{LOAD} = 1A$ , negative clamp <sup>(5)(8)</sup>			-2.5	
		$I_{LOAD} = 5A$ , positive clamp <sup>(5)(8)</sup>			11.5	
		$I_{LOAD} = 5A$ , negative clamp <sup>(5)(8)</sup>			-3.5	
		$I_{LOAD} = 12A$ , positive clamp <sup>(5)(8)</sup>			14.0	
		I <sub>LOAD</sub> = 12A, negative clamp <sup>(5)(8)</sup>			-5.0	
R <sub>CH</sub>	Total Series Resistance	$I_R = 20mA$	90	100	110	Ω
C <sub>CH</sub>	Channel Capacitance	Input to Ground <sup>(6)(7)(8)</sup>	7	8	9	pF
f <sub>C</sub>	Cut-off Frequency	Measured with $50\Omega$ source and $50\Omega$ load termination		220		MHz
	Attenuation from 700MHz to 3.0GHz	$\mbox{V}_{\mbox{\scriptsize R}} = 0\mbox{\scriptsize V}$ Measured with $50\Omega$ source and $50\Omega$ load termination		-20		dB

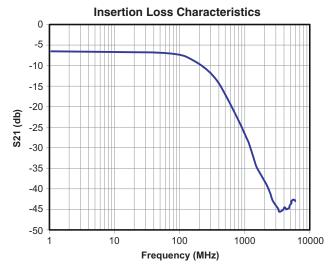
#### Notes:

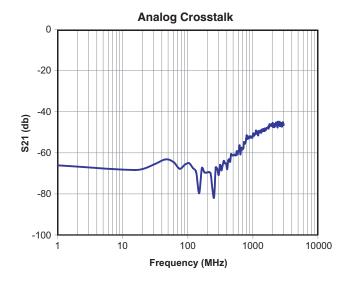
- $3. \ The \ working \ peak \ reverse \ voltage, \ V_{RWM}, \ should \ be \ equal \ to \ or \ greater \ than \ the \ DC \ or \ continuous \ peak \ operating \ voltage \ level.$
- 4.  $V_{BR}$  is measured at the pulse test current  $I_{T}$ .
- 5. Measurements performed using a 100ns Transmission Line Pulse (TLP) system.
- 6. Total capacitance is equal to 2 x  $C_{CH}$ .
- 7. Measured at 25°C,  $V_R = 2.5V$ , f = 1.0MHz.
- 8. Guaranteed by design.

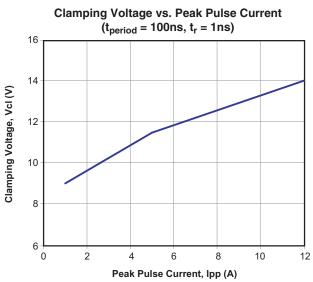
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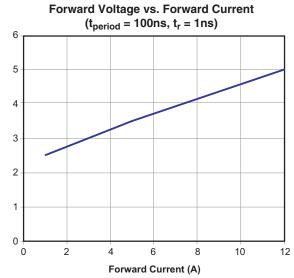


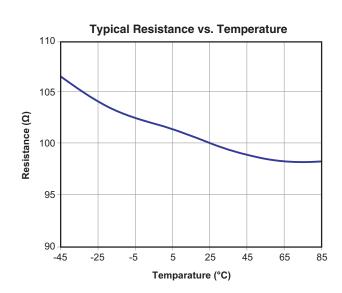
### **Typical Performance Characteristics**







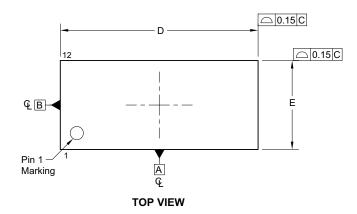


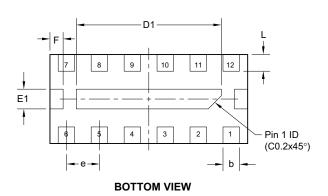


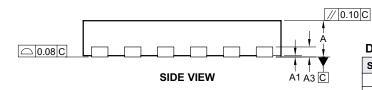
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### Package Dimensions, DFN 3 x 1.35A







### Dimensions in millimeters

Symbols	Min.	Nom.	Max.			
Α	0.50	0.55	0.60			
A1	0.00	_	0.05			
A3	A3 0.152 REF					
b	0.20	0.25	0.30			
D	2.95	3.00	3.05			
D1	2.15	2.20	2.25			
E	1.30	1.35	1.40			
E1	0.25	0.30	0.35			
е	0.50 BSC					
L	0.20	0.25	0.35			
F	(	).20 REF	:			

### Dimensions in inches

Symbols	Min.	Nom.	Max.		
Α	0.020	0.022	0.024		
A1	0.000		0.002		
A3	0.020 0.022 0.0 0.000 — 0.0 0.006 REF 0.008 0.010 0.0 0.116 0.118 0.1 0.085 0.087 0.0 0.051 0.053 0.0				
b	0.008	0.010	0.012		
D	0.116	0.118	0.120		
D1	0.085	0.087	0.089		
E	0.051	0.053	0.055		
E1	0.010	0.012	0.014		
е	0.020 BSC				
L	0.008	0.010	0.012		
F	0.008 REF				

#### RECOMMENDED LAND PATTERN

0.20 —		•	2.5	20 ——		0.30
0.20		$\Box$	+	+	+	
0.30						1.15
Ť	+	+	+	+	+	+
	0.50	-	0.25	•		- 0.25 UNIT: mm

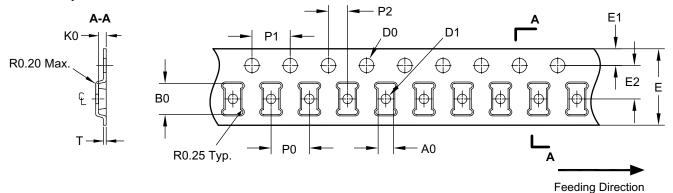
#### Notes:

- 1. All dimensions are in millimeters. Angles is degree.
- 2. Coplanarity applies to the exposed pad as well as the terminals. Coplanarity shall not exceed 0.08mm.
- 3. Warpage shall not exceed 0.10mm.
- 4. Package length/package width are not considered as special characteristic.
- 5. Refer JEDEC MO-229.
- 6. Marking is for package orientation reference only.



### Tape and Reel Dimensions, DFN 3 x 1.35A

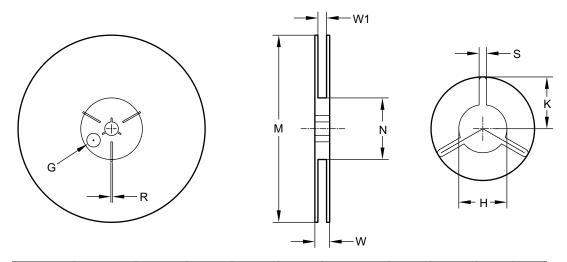
### **Carrier Tape**



Unit: mm

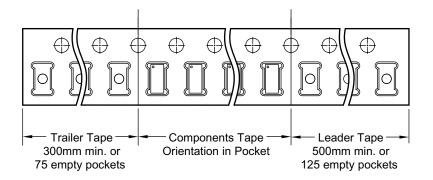
Package	A0	В0	K0	D0	D1	E	E1	E2	P0	P1	P2	Т
DFN	1.60	3.25	0.80	ø1.5	ø1.00	8.0	1.75	3.50	4.00	4.00	2.00	0.30
3x1.35	±0.10	±0.10	±0.10	+0.1/-0.0	Min.	+0.3/-0.1	±0.10	±0.05	±0.10	±0.10	±0.05	±0.05

#### Reel



Tape Size	Reel Size	М	N	W	W1	Н	S	K	G	R
8mm	ø178	ø178.0	ø60.0	11.80	9.0	ø13.0	2.40	10.25	ø9.8	_
		±1.0	±1.0	+0.5	±0.5	+0.5/-0.2	±0.10	±0.2		

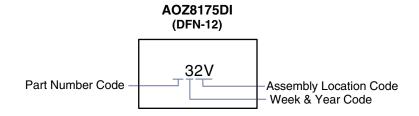
## Leader / Trailer & Orientation



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### **Part Marking**



This data sheet contains preliminary data; supplementary data may be published at a later date. Alpha & Omega Semiconductor reserves the right to make changes at any time without notice.

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